



	LAA125L	Units
Load Voltage	350	V
Load Current	150	mA
Max R _{ON}	18	Ω

Features

- Small 8 Pin DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 3750VRMS Input/Output Isolation
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available
- Current Limiting Surface Mount and Tape and Reel Versions Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hookswitch
 - Dial Pulsing
 - Ground Start
 - Ringer Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
 - Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

LAA125L is a 350V, 150mA, 18Ω 2-Form-A relay. It combines enhanced peak load current capability with low on-resistance. Current limiting version is available ("L" suffix, see specification for variations in performance).

Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- BSI Certified to:
 - BS EN 60950:1992 (BS7002:1992)
Certificate #: 7344
 - BS EN 41003:1993
Certificate #: 7344

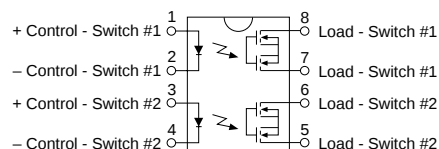
Ordering Information

Part #	Description
LAA125L	8 Pin DIP (50/Tube)
LAA125LS	8 Pin Surface Mount (50/Tube)
LAA125LSTR	8 Pin Surface Mount (1,000/Reel)
LAA125PL	8 Pin Flat Pack (50/Tube)
LAA125PLTR	8 Pin Flat Pack (1,000/Reel)

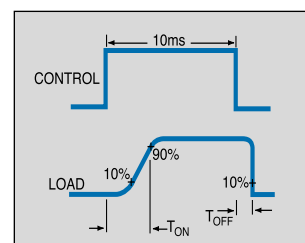
Pin Configuration

LAA125L Pinout

AC/DC Configuration



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	150 ¹	mW
Input Control Current	-	-	50	mA
Peak (10ms)	-	-	1	A
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	800 ²	mW
Capacitance Input to Output	-	3	-	pF
Isolation Voltage Input to Output	3750	-	-	V _{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature DIP Package	-	-	+260	°C
Flatpack/Surface Mount Package (10 Seconds Max.)	-	-	+220	°C

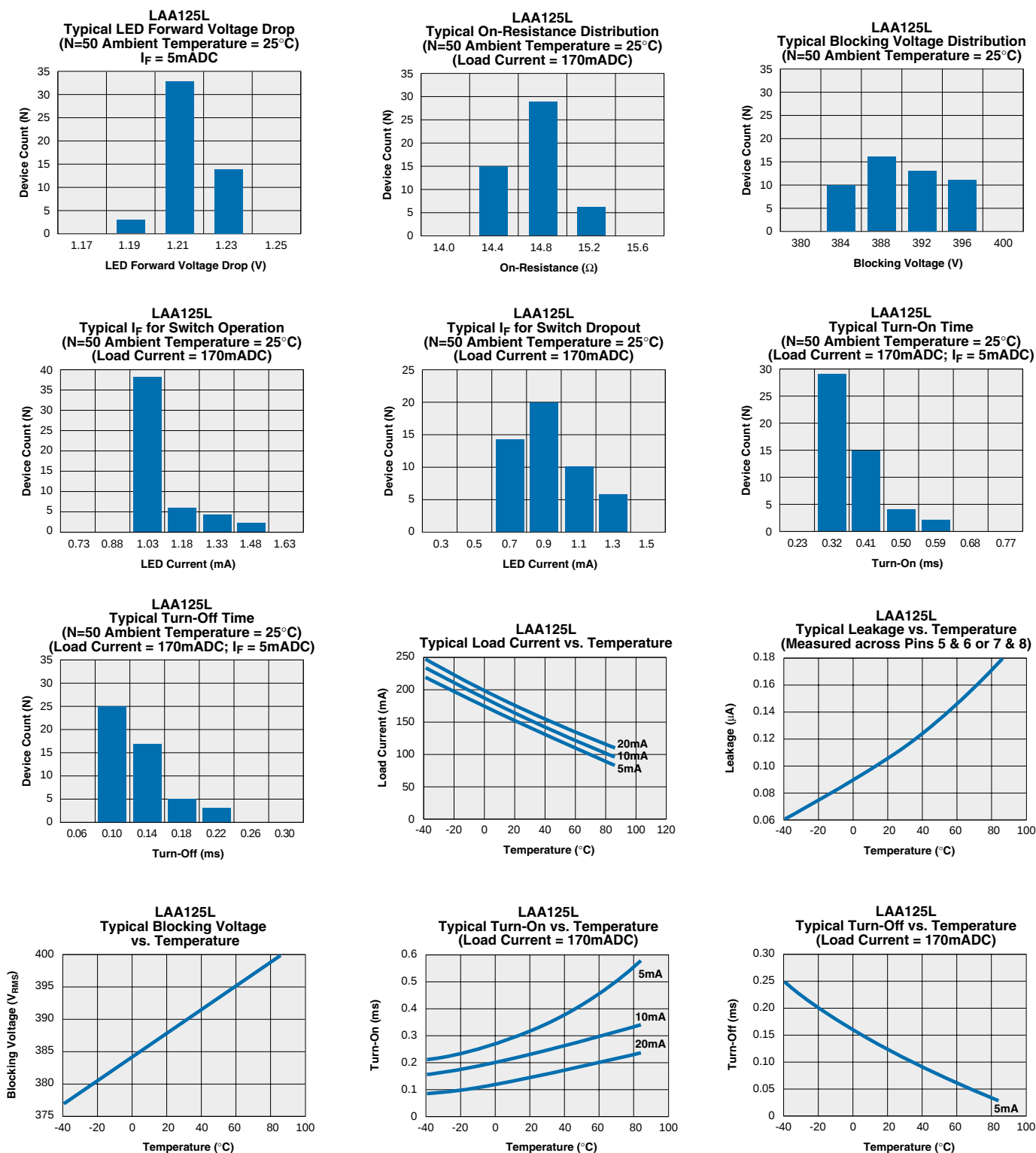
¹ Derate Linearly 1.33 mW/°C² Derate Linearly 6.67 mW/°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

Electrical Characteristics

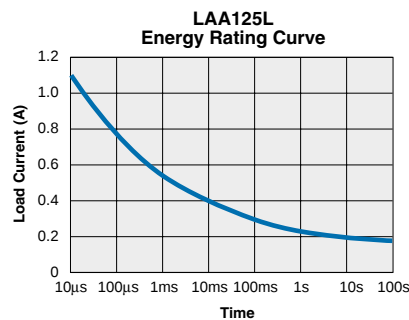
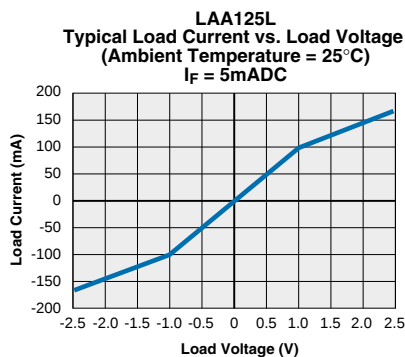
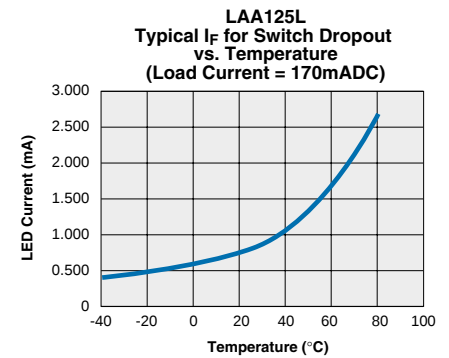
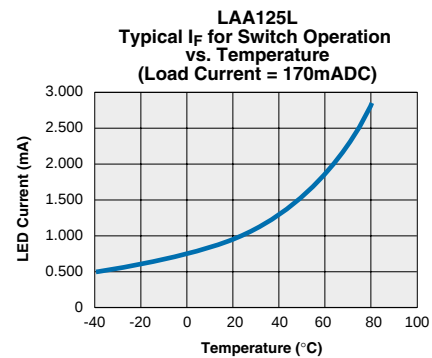
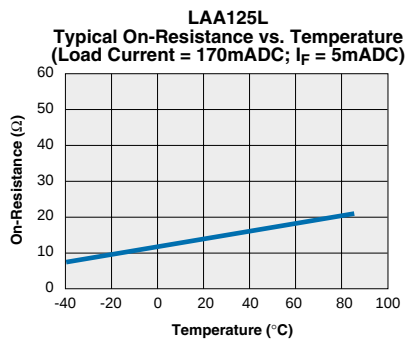
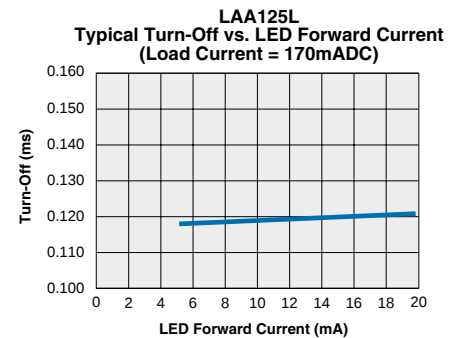
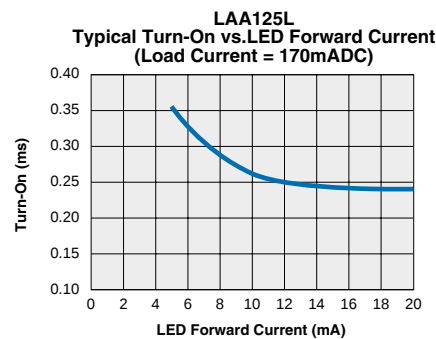
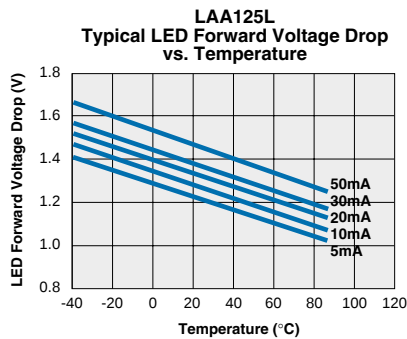
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Voltage (Peak)	-	V _L	-	-	350	V
Load Current (Continuous) AC/DC Configuration	-	I _L	-	-	150	mA
Peak Load Current	10ms max	I _{LPK}	-	-	400	mA
On-Resistance AC/DC Configuration	I _L =Load Current	R _{ON}	-	-	18	Ω
Off-State Leakage Current	V _L =350V	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	5	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	5	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	50	-	pF
Load Current Limiting		I _{CL}	190	235	250	mA
Input Characteristics @ 25°C						
Input Control Current	I _L =170mA	I _F	5	-	50	mA
Input Dropout Current	-	-	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF
Input to Output Isolation	-	V _{I/O}	3750	-	-	V _{RMS}

Performance Data*



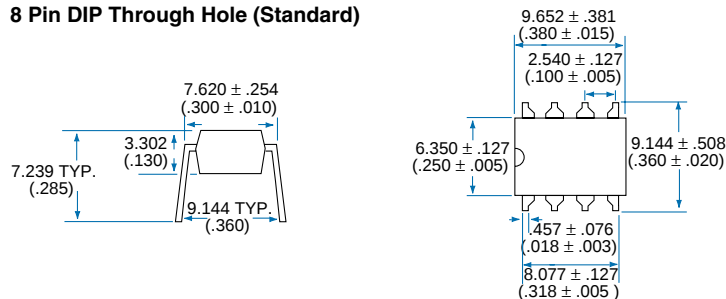
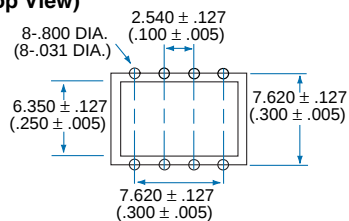
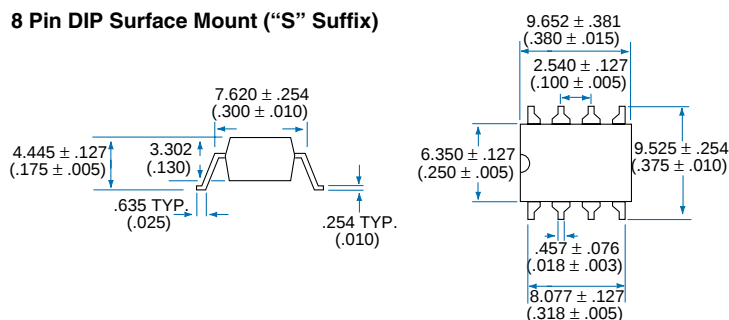
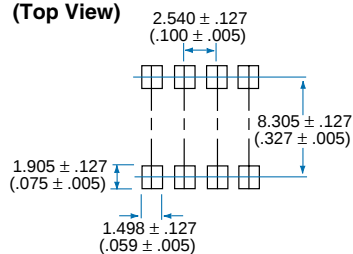
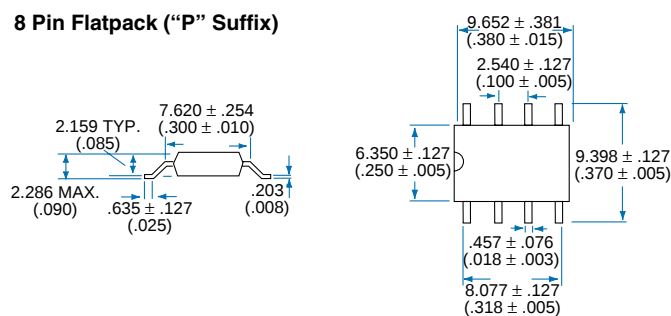
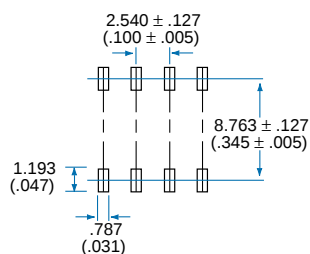
The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Performance Data*



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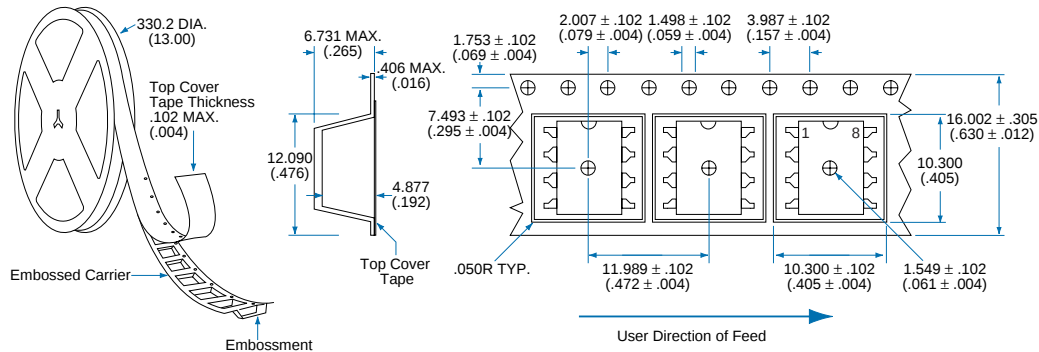
MECHANICAL DIMENSIONS

8 Pin DIP Through Hole (Standard)

PC Board Pattern (Top View)

8 Pin DIP Surface Mount ("S" Suffix)

PC Board Pattern (Top View)

8 Pin Flatpack ("P" Suffix)

PC Board Pattern (Top View)


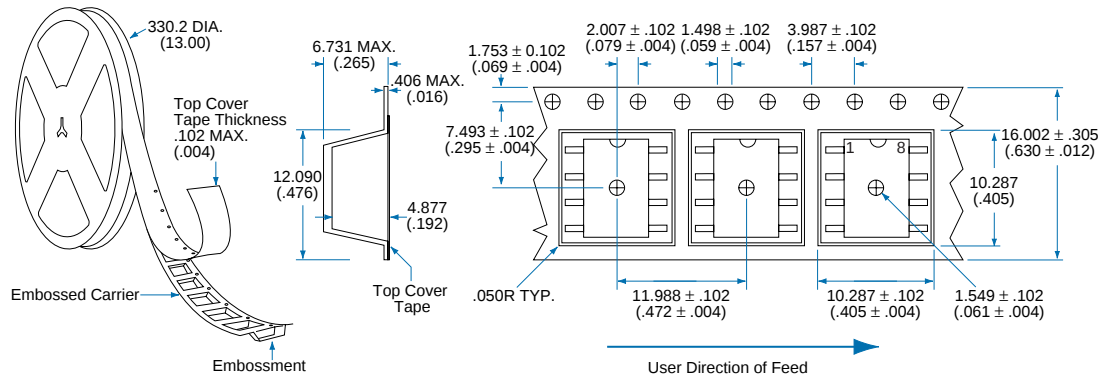
Dimensions
mm
(inches)

MECHANICAL DIMENSIONS

Tape and Reel Packaging for 8 Pin Surface Mount Package



Tape and Reel Packaging for 8 Pin Flatpack Package



Dimensions
mm
(inches)



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